(   ) **Preliminary Specification**
(V) **Final Specification**

Module	24" Color TFT-LCD
Model Name	M240HW01 VD

Customer	Date
Approved by	

Approved by	Date
Howard Lee	2012/3/13
Prepared by	
James Weng	2012/3/13

Note: This Specification is subject to change without notice.

Desktop Display Business Group /
AU Optronics corporation

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Record of Revision

Version and Date	Page	Old description	New Description	Remark

1.0 Handling Precautions

1) Since front polarizer is easily damaged, pay attention not to scratch it.

2) Be sure to turn off power supply when inserting or disconnecting from input connector.

3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.

4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.

5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.

6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.

7) Do not open or modify the Module Assembly.

8) Do not press the reflector sheet at the back of the module to any directions.

9) In case if a Module has to be put back into the packing container slot after once it was taken out from the container, do not press the center of the LED lightbar edge. Instead, press at the far ends of the LED light bar edge softly. Otherwise the TFT Module may be damaged.

10) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.

11) After installation of the TFT Module into an enclosure, do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.

12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.

13) Please avoid touching COF position while you are doing mechanical design

14) When storing modules as spares for a long time, the following precaution is necessary:
Store them in a dark place. Do not expose the module to sunlight or fluorescent light. Keep the temperature between 5℃ and 35℃ at normal humidity.

2.0 General Description

This specification applies to the 24 inch-FHD Color a-Si TFT-LCD Module M240HW01. The display supports the FHD - 1920(H) x 1080(V) screen format and 16.7M colors (RGB 6-bits + Hi-FRC data). The light source of this TFT-LCD module is W-LED. All input signals are 2-channel LVDS interface and this module doesn't contain a driver for backlight.

2.1 Display Characteristics

The following items are characteristics summary on the table under 25℃ condition:

| ITEMS	Unit	SPECIFICATIONS
Screen Diagonal	[mm]	609.7(24.0")
Active Area	[mm]	531.36 (H) x 298.89 (V)
Pixels H x V		1920(x3) x 1080
Pixel Pitch	[um]	276.75 (per one triad) ×276.75
Pixel Arrangement		R.G.B. Vertical Stripe
Display Mode		TN Mode, Normally White
Optical Response Time	[msec]	5ms (Typ., on/off)
Nominal Input Voltage VDD	[Volt]	+5.0 V (Typ)
Power Consumption (VDD line + LED line)	[Watt]	3.25 (Typ.,60 Hz)
Weight	[Grams]	650 (typ.)
Electrical Interface		Dual channel LVDS
Support Color		16.7M colors (RGB 6-bit + Hi_FRC)
Surface Treatment		Anti-Glare, 3H
Cell transmittance		5.34%
Cell thickness	[mm]	1.9

2.2 Optical Characteristics

The optical characteristics are measured under stable conditions at 25℃ :

| Item	Unit	Conditions	Min.	Typ.	Max.	Note
Response Time	[msec]	Raising Time (T_{rR})	-	3.5	7.4	1,2
		Falling Time (T_{rF})	-	1.5	2.6	
		Raising + Falling	-	5	10	
Crosstalk (in 60Hz)	[%]				1.5	3
Flicker	dB				-20	4

***Note 1:* Measurement method**

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring (at surface 35℃). In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 30 minutes in a stable, windless and dark room.

Photo detector

Measured distance

LCD Panel

TFT-LCD Module

Center of the screen
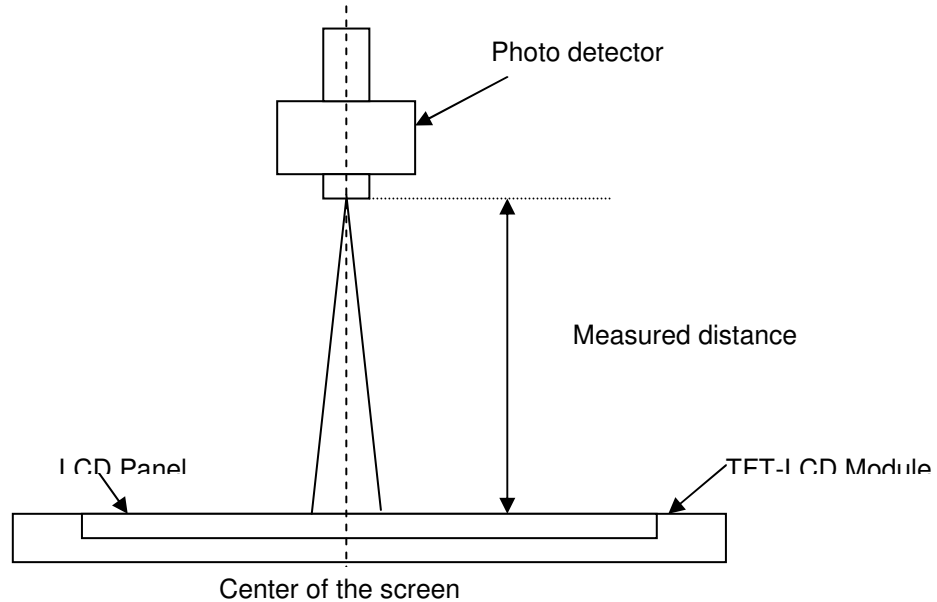
***Note 2:*Definition of Response time** measured by Westar TRD-100A

The output signals of photo detector are measured when the input signals are changed from "Full Black" to "Full White" (rising time, T_{rR}), and from "Full White" to "Full Black" (falling time, T_{rF}), respectively. The response time is interval between the 10% and 90% (1 frame at 60 Hz) of amplitudes.

T_{rF} T_{rR}

%

100
90

Optical response

White Black Black White

10
0

1 Frame 1 Frame
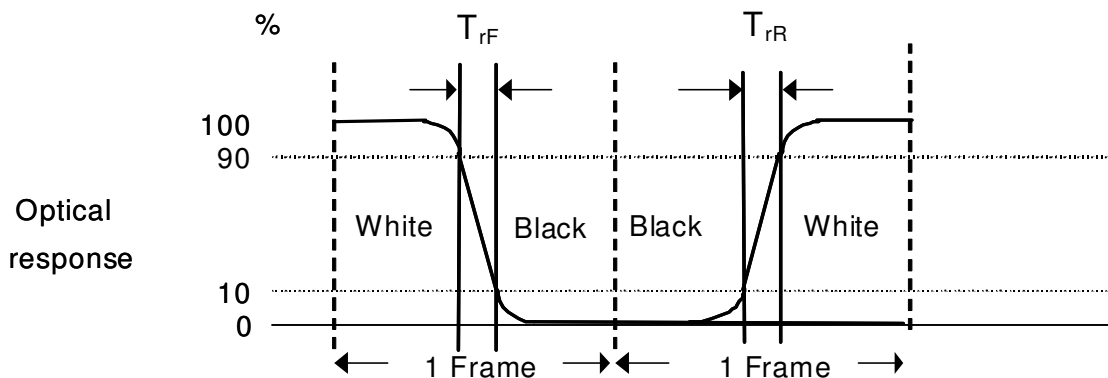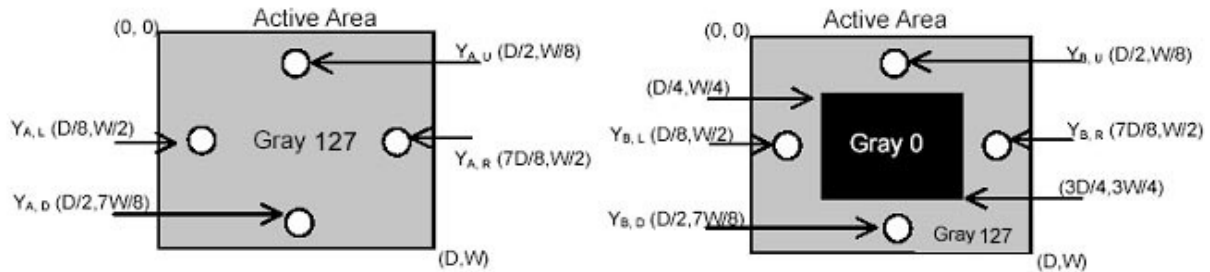
$T_{rR} + T_{rF} = 5$ msec (typ.).

***Note 3* Crosstalk is defined as below and** measured by TOPCON SR-3

$$CT = | YB - YA | / YA \times 100 \ (\%)$$
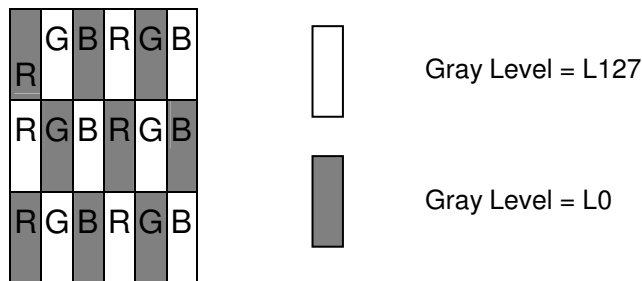
Where

YA = Luminance of measured location without gray level 0 pattern (cd/m2)

YB = Luminance of measured location with gray level 0 pattern (cd/m2)

Note 4 **Test Patern: Subchecker Pattern** measured by TOPCON SR-3

Gray Level = L127

Gray Level = L0

Method: Record dBV & DC value with TRD-100

$$Flicker\,(dB) = 20\log\frac{AC\ Level(at\,30\,Hz)}{DC\ Level}$$
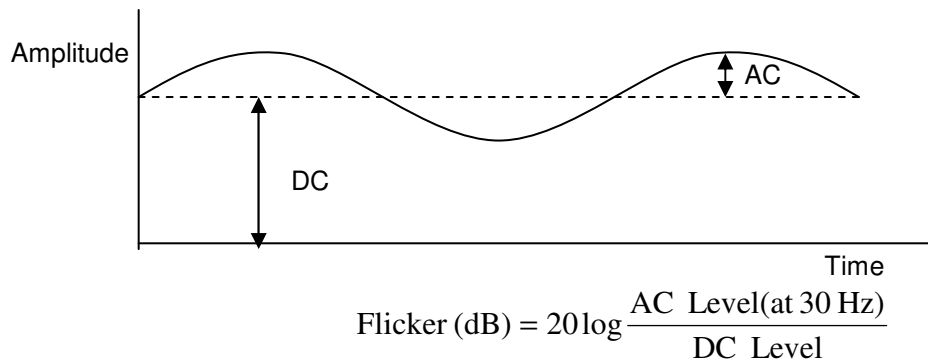
3.0 Functional Block Diagram

The following diagram shows the functional block of the 24.0 inch Color TFT-LCD Module:
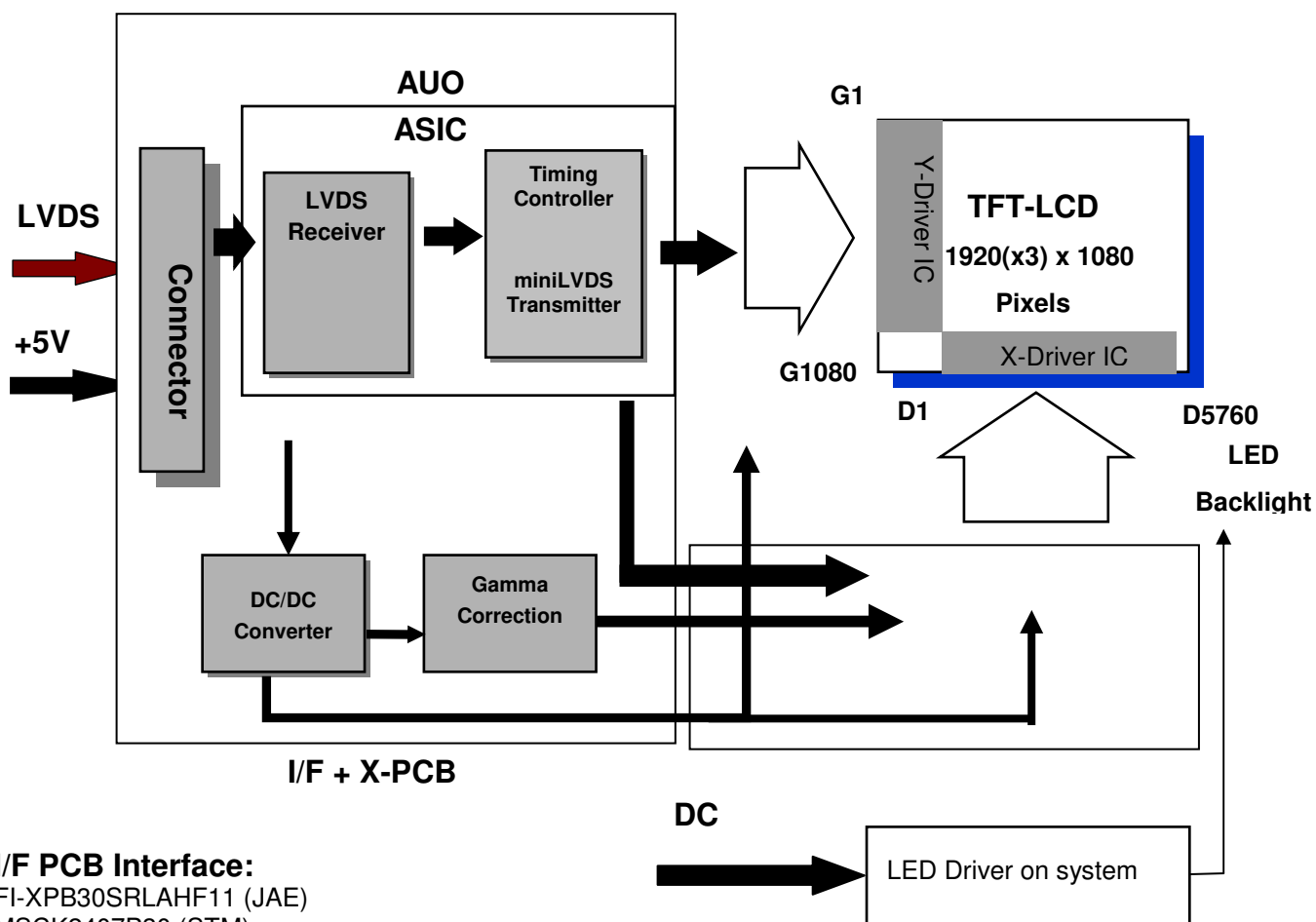
I/F PCB Interface:
FI-XPB30SRLAHF11 (JAE)
MSCK2407P30 (STM)

Mating Type:

FI-X30HL(Locked Type)

4.0 Absolute Maximum Ratings

Absolute maximum ratings of the module are as following:

4.1 TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	VDD	0	6.0	[Volt]	**Note 1,2**

4.2 Absolute Ratings of Environment

Item	Symbol	Min.	Max.	Unit	Conditions
Operating Temperature	TOP	0	+50	[^{o}C]	
Center Glass surface temperature (operation)	TGS	0	+50	[^{o}C]	
Operation Humidity	HOP	5	90	[%RH]	**Note 3**
Storage Temperature	TST	-20	+60	[^{o}C]	
Storage Humidity	HST	5	90	[%RH]	

Note 1: With in Ta (25℃)
Note 2: Permanent damage to the device may occur if exceeding maximum values
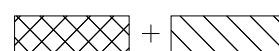**Note 3:** For quality perfermance, please refer to AUO IIS(Incoming Inspection Standard).

   1. 90% RH Max (Ta ≦39℃)
   2. Max wet-bulb temperature at 39℃ or less. (Ta ≦39℃)
   3. No condensation
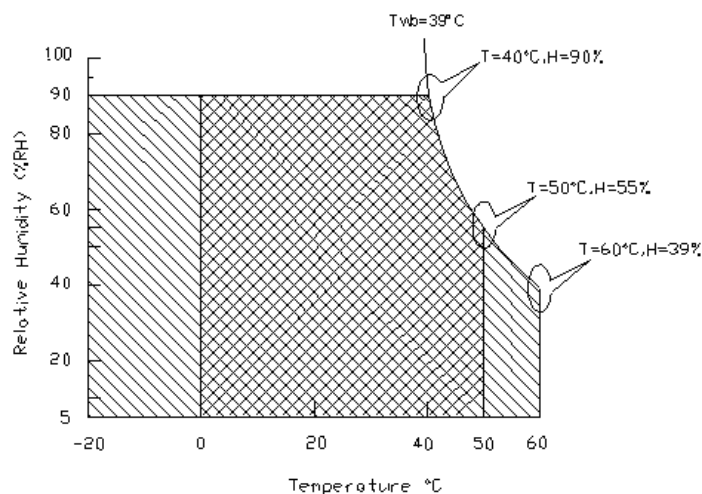
Operating Range   ☒☒☒   Storage Range   ☒☒☒ + ▨▨▨
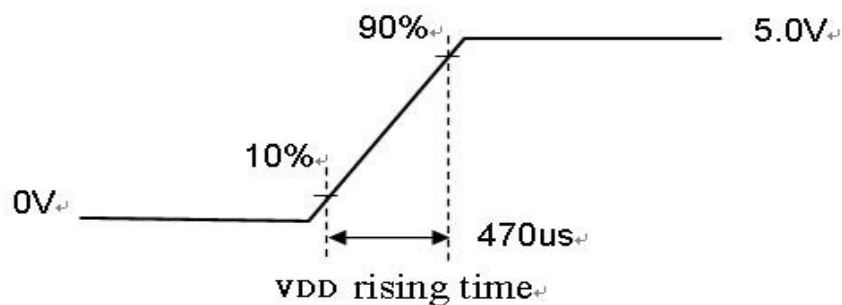
5.0 Electrical characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

Input power specifications are as following:

Symbol	Parameter	Min	Typ	Max	Unit	Conditions
VDD	Logic/LCD Drive Voltage	4.5	5.0	5.5	[Volt]	+/-10%
IDD	Input Current	-	0.65	0.78	[A]	VDD= 5.0V,All black Pattern, At 60Hz
			0.8	0.96	[A]	VDD= 5.0V, All Black Pattern At 75Hz,
PDD	VDD Power	-	3.25	3.9	[Watt]	VDD= 5.0V,All black Pattern, At 60Hz
			4	4.8	[Watt]	VDD= 5.0V, All Black Pattern At 75Hz
IRush	Inrush Current	-	-	3	[A]	**Note 1**
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	500	[mV] p-p	VDD= 5.0V, All Black Pattern At 75Hz

Note 1: Measurement conditions:

The duration of rising time of power input is 470us.
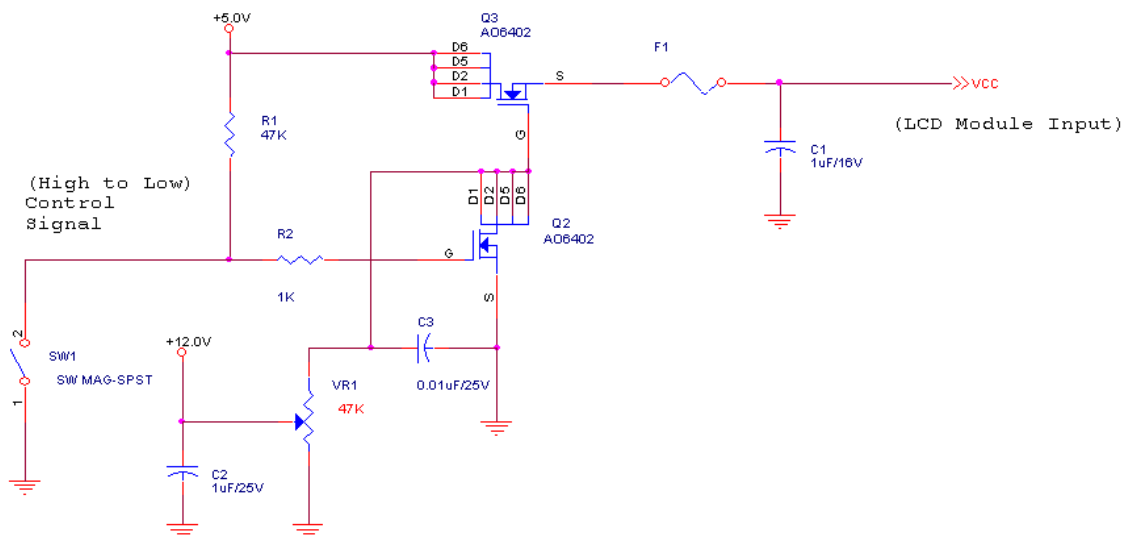
5.1.2 Signal Electrical Characteristics

Input signals shall be low or Hi-Z state when VDD is off. Please refer to specifications of SN75LVDS82DGG (Texas Instruments) in detail.

1. DC Characteristics of each signal are as following:

Symbol	Parameter	Min	Typ	Max	Units	Condition
V_{TH}	Differential Input High Threshold	-	-	+100	[mV]	V_{CM} = 1.2V **Note 1**
V_{TL}	Differential Input Low Threshold	-100	-	-	[mV]	V_{CM} = 1.2V **Note 1**
$|V_{ID}|$	Input Differential Voltage	100	-	600	[mV]	**Note 1**
V_{CM}	Differential Input Common Mode Voltage	+1.0	+1.2	+1.5	[V]	V_{TH}-V_{TL} = 200MV (max) **Note 1**

Note 1: LVDS Signal Waveform
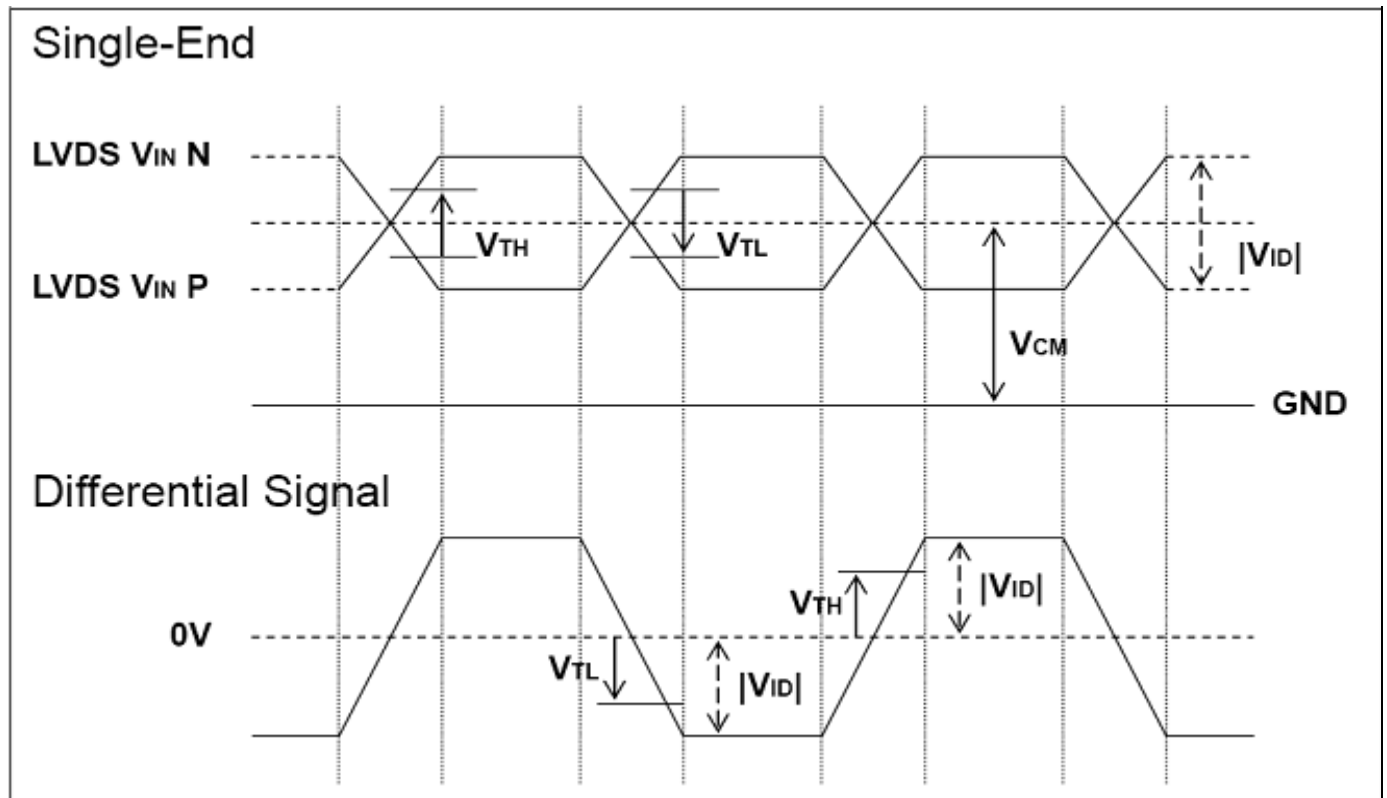
2. AC Characteristics

Description	Symbol	Min	Max	Unit	Note
Maximum deviation of input clock frequency during SSC	F_{DEV}	-	$\pm$ 3	%	
Maximum modulation frequency of input clock during SSC	F_{MOD}	-	300	KHz	

< Spread Spectrum>
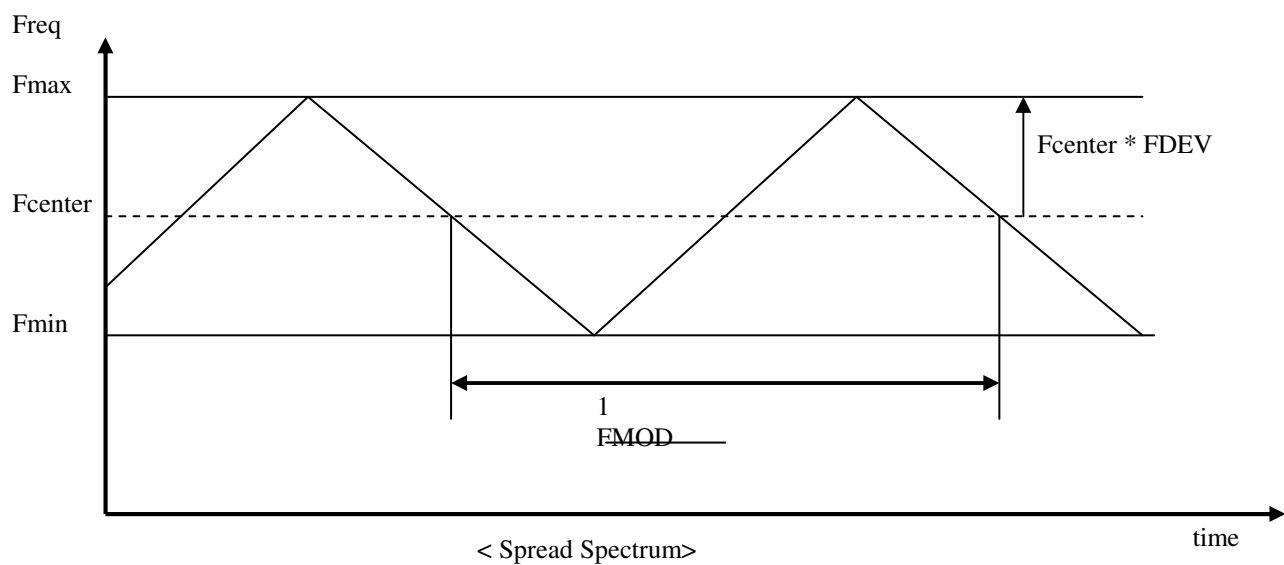
6.0 Signal Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

	1	2		1919	1920
1st Line	R G B	R G B	· · · · · · · · · · ·	R G B	R G B
1080 Line	R G B	R G B	· · · · · · · · · · · · ·	R G B	R G B

6.2 The input data format

RXOCLK+
RXOCLK-

RXO0 : OG0 OR5 OR4 OR3 OR2 OR1 OR0
RXO1 : OB1 OB0 OG5 OG4 OG3 OG2 OG1
RXO2 : DE OB5 OB4 OB3 OB2
RXO3 : RSV OB7 OB6 OG7 OG6 OR7 OR6

RXECLK+
RXECLK-

RXE0 : EG0 ER5 ER4 ER3 ER2 ER1 ER0
RXE1 : EB1 EB0 EG5 EG4 EG3 EG2 EG1
RXE2 : EB5 EB4 EB3 EB2
RXE3 : RSV EB7 EB6 EG7 EG6 ER7 ER6
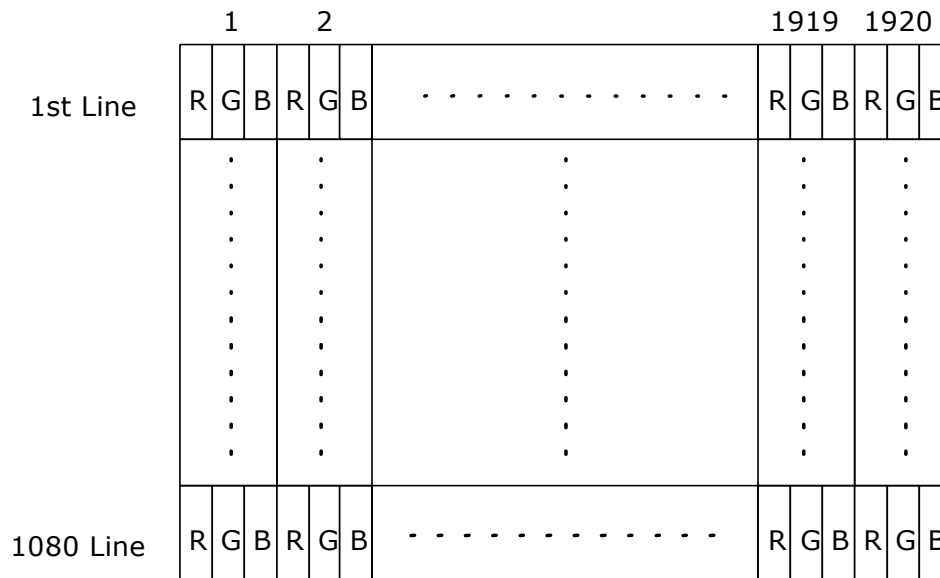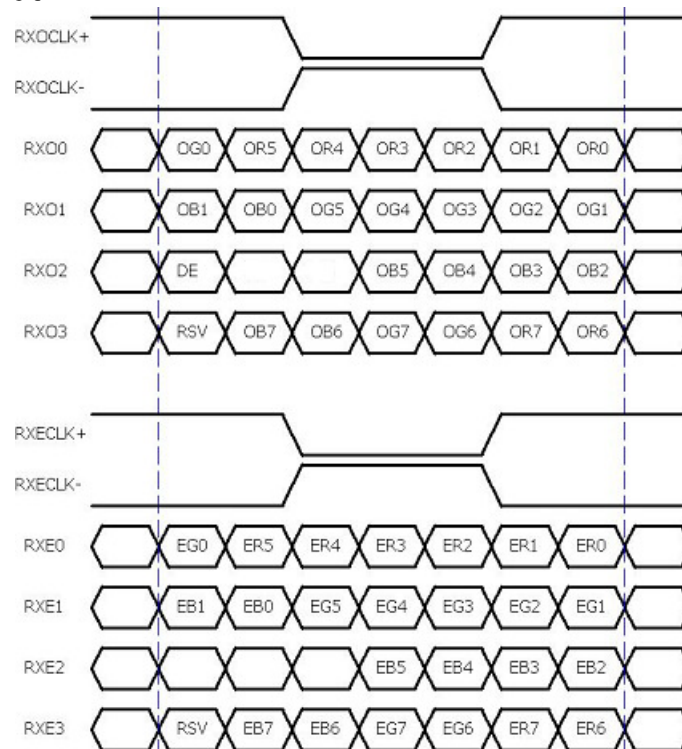
Note 1: R/G/B data 7:MSB, R/G/B data 0:LSB   O = "Odd Pixel Data"   E = "Even Pixel Data"

6.3 Signal Description

The module using one LVDS receiver SN75LVDS82(Texas Instruments). LVDS is a differential signal technology for LCD interface and high speed data transfer device. LVDS transmitters shall be SN75LVDS83(negative edge sampling). The first LVDS port(RxOxxx) transmits odd pixels while the second LVDS port(RxExxx) transmits even pixels.

PIN #	SIGNAL NAME	DESCRIPTION
1	RxOIN0-	Negative LVDS differential data input (Odd data)
2	RxOIN0+	Positive LVDS differential data input (Odd data)
3	RxOIN1-	Negative LVDS differential data input (Odd data)
4	RxOIN1+	Positive LVDS differential data input (Odd data)
5	RxOIN2-	Negative LVDS differential data input (Odd data, DSPTMG)
6	RxOIN2+	Positive LVDS differential data input (Odd data, DSPTMG)
7	GND	Power Ground
8	RxOCLK-	Negative LVDS differential clock input (Odd clock)
9	RxOCLK+	Positive LVDS differential clock input (Odd clock)
10	RxOIN3-	Negative LVDS differential data input (Odd data)
11	RxOIN3+	Positive LVDS differential data input (Odd data)
12	RxEIN0-	Negative LVDS differential data input (Even data)
13	RxEIN0+	Positive LVDS differential data input (Even data)
14	GND	Power Ground
15	RxEIN1-	Positive LVDS differential data input (Even data)
16	RxEIN1+	Negative LVDS differential data input (Even data)
17	GND	Power Ground
18	RxEIN2-	Negative LVDS differential data input (Even data)
19	RxEIN2+	Positive LVDS differential data input (Even data)
20	RxECLK-	Negative LVDS differential clock input (Even clock)
21	RxECLK+	Positive LVDS differential clock input (Even clock)
22	RxEIN3-	Negative LVDS differential data input (Even data)
23	RxEIN3+	Positive LVDS differential data input (Even data)
24	GND	Power Ground
25	NC	No connection (for AUO test only. Do not connect)
26	NC	No connection (for AUO test only. Do not connect)
27	NC	No connection (for AUO test only. Do not connect)
28	VDD	Power +5V
29	VDD	Power +5V
30	VDD	Power +5V

Note1: Start from left side

BLU LABEL

SHIPPING LABEL

1   30

RxOIN0-   VDD
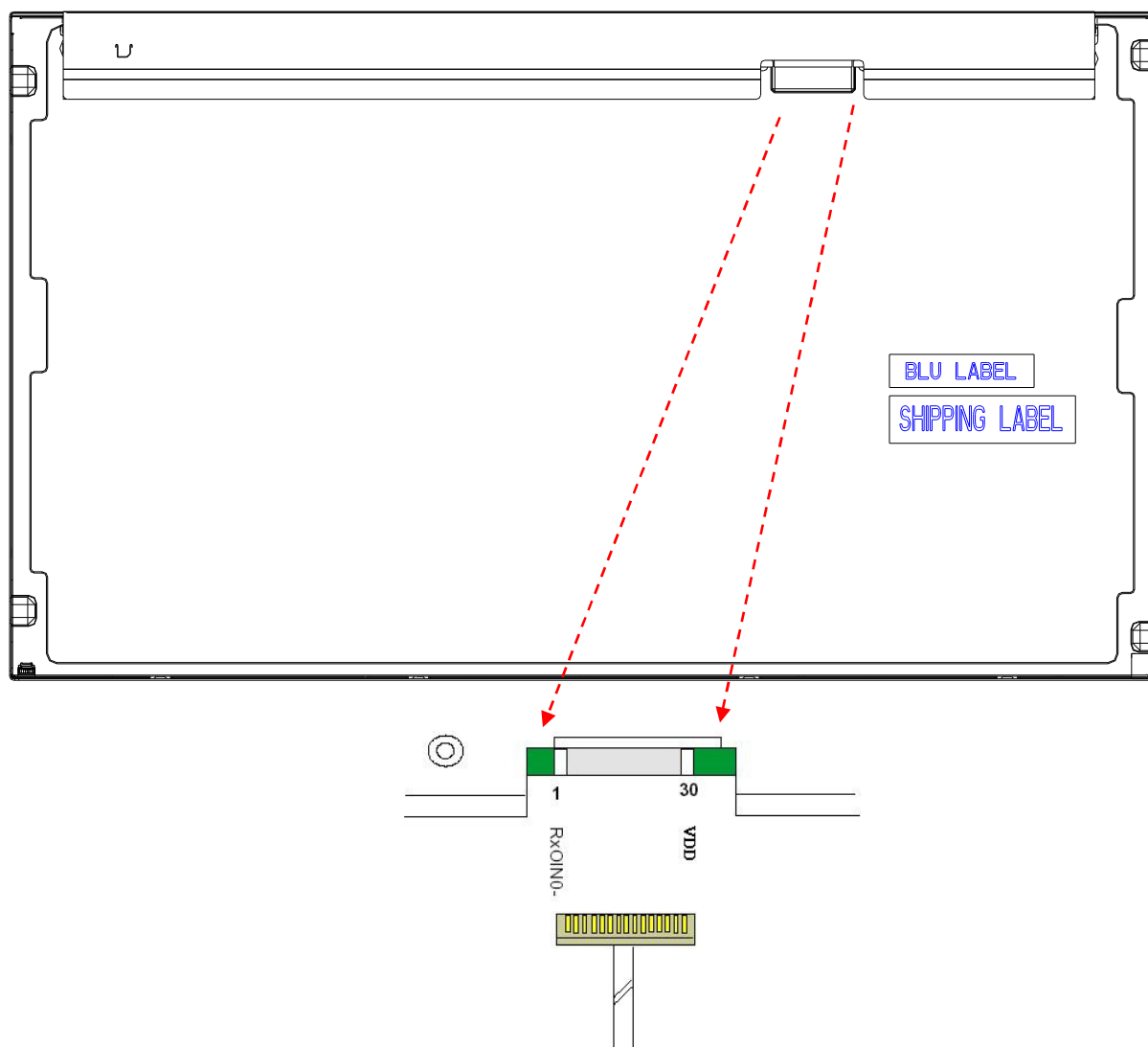
*Note2:* Input signals of odd and even clock shall be the same timing.

6.4 Timing Characteristics

Basically, interface timing described here is not actual input timing of LCD module but close to output timing of SN75LVDS82DGG (Texas Instruments) or equivalent.

| Signal	Item	Symbol	Min	Typ	Max	Unit
Vertical Section	Period	Tv	1088	1120	2047	Th
	Active	Tdisp(v)	1080	1080	1080	Th
	Blanking	Tbp(v)+Tfp(v)+PWvs	8	40	967	Th
Horizontal Section	Period	Th	1034	1060	2047	Tclk
	Active	Tdisp(h)	960	960	960	Tclk
	Blanking	Tbp(h)+Tfp(h)+PWhs	74	100	1087	Tclk
Clock	Period	Tclk	25	13.3	11.1	ns
	Frequency	Freq	40	75	90	MHz
Frame rate	Frame rate	F	50	60	75	Hz

Note : DE mode only

6.5 Timing diagram
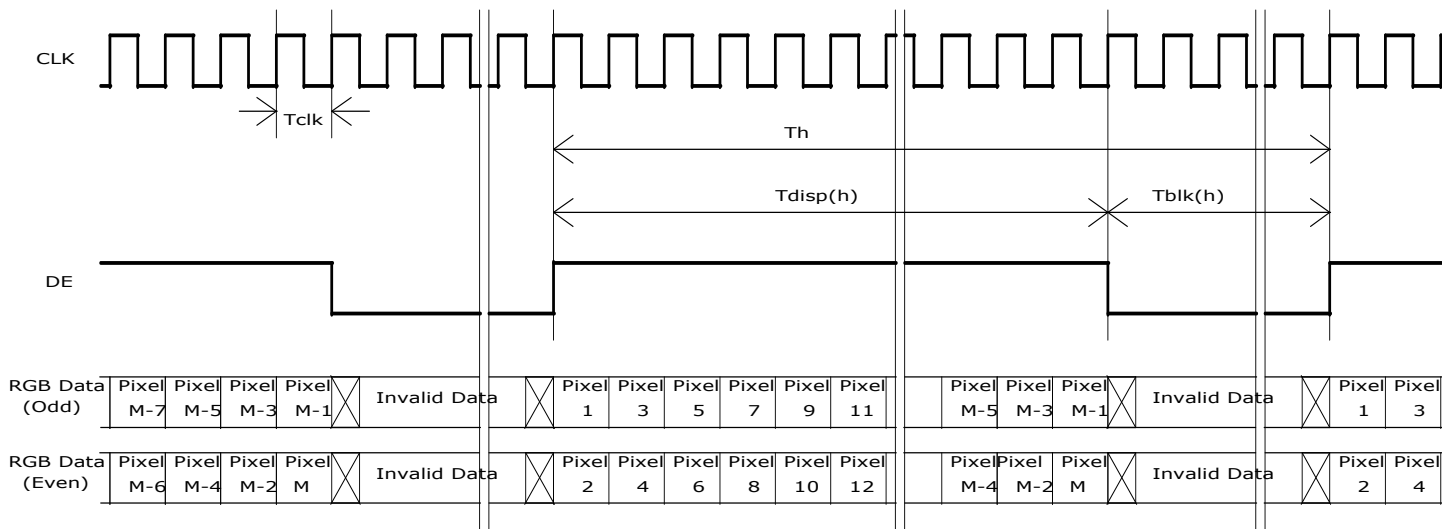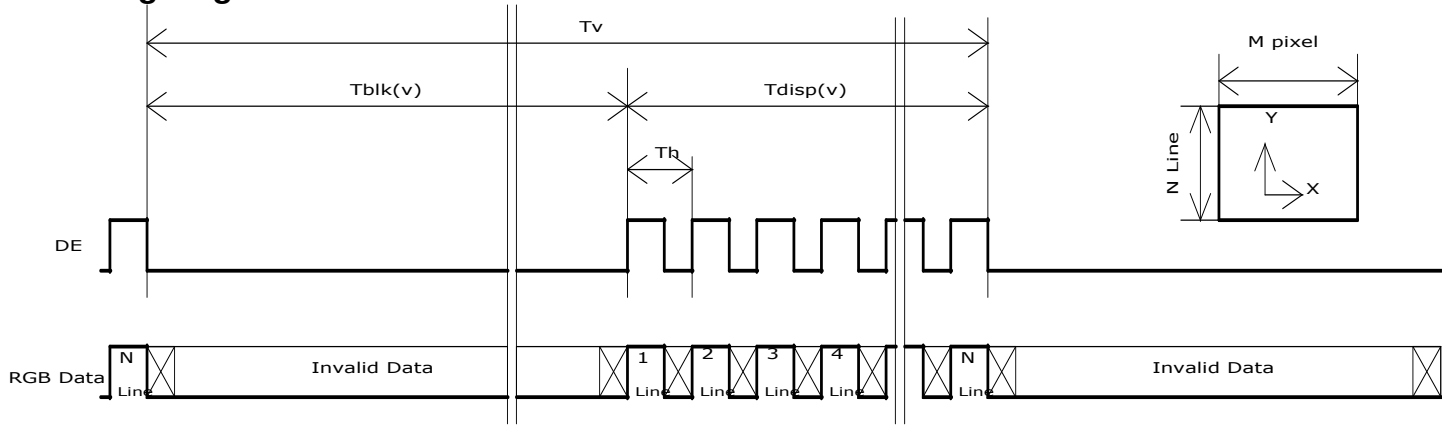
6.6 Power ON/OFF Sequence

VDD power and lamp on/off sequence are as follows. Interface signals are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off.
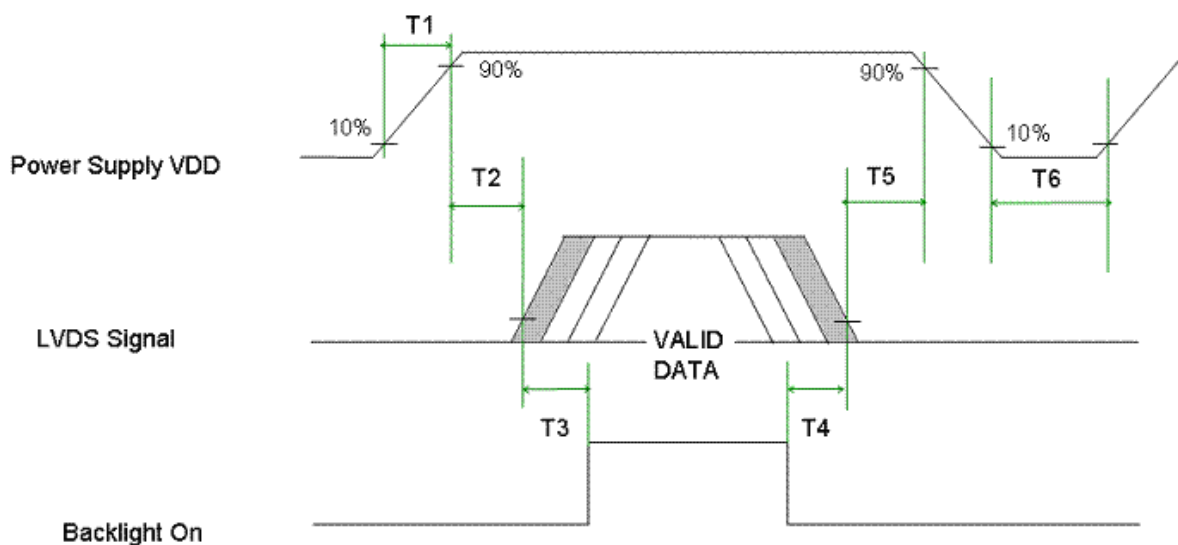
Note 1: Insert a black pattern

Note 2: Insert a white pattern

Parameter	Value		Unit
	Min.	Max.	
T1	0.5	10	[msec]
T2	0	50	[msec]
T3	500	-	[msec]
T4	200	-	[msec]
T5	0	50	[msec]
T6	1000	-	[msec]

7.0 Connector & Pin Assignment

Physical interface is described as for the connector on module. These connectors are capable of accommodating the following signals and will be following components.

7.1 TFT LCD Module

Connector Name / Designation	Interface Connector / Interface card
Manufacturer	JAE STM
Type Part Number	FI-XPB30SRLAHF11 MSCK2407P30
Mating Housing Part Number	FI-X30HL (Locked Type)

7.1.1 Pin Assignment

Pin#	Signal Name	Pin#	Signal Name
1	RxOIN0-	2	RxOIN0+
3	RxOIN1-	4	RxOIN1+
5	RxOIN2-	6	RxOIN2+
7	GND	8	RxOCLKIN-
9	RxOCLKIN+	10	RxOIN3-
11	RxOIN3+	12	RxEIN0-
13	RxEIN0+	14	GND
15	RxEIN1-	16	RxEIN1+
17	GND	18	RxEIN2-
19	RxEIN2+	20	RxECLKIN-
21	RxECLKIN+	22	RxEIN3-
23	RxEIN3+	24	GND
25	NC (for AUO test only. Do not connect)	26	NC (for AUO test only. Do not connect)
27	NC (for AUO test only. Do not connect)	28	VDD
29	VDD	30	VDD

8.0 Reliability Test

Environment test conditions are listed as following table.

Items	Required Condition	Note
Temperature Humidity Bias (THB)	Ta= 50℃, 80%RH, 300hours	
High Temperature Operation (HTO)	Ta= 50℃, 50%RH, 300hours	
Low Temperature Operation (LTO)	Ta= 0℃, 300hours	
High Temperature Storage (HTS)	Ta= 60℃, 300hours	
Low Temperature Storage (LTS)	Ta= -20℃, 300hours	
Vibration Test (Non-operation)	Acceleration: 1.5 Grms Wave: Random Frequency: 10 - 200 Hz Duration: 30 Minutes each Axis (X, Y, Z)	
Shock Test (Non-operation)	Acceleration: 50 G Wave: Half-sine Active Time: 20 ms Direction: ±X, ±Y, ±Z (one time for each Axis)	
Drop Test	Height: 46 cm, package test	
Thermal Shock Test (TST)	-20℃/30min, 60℃/30min, 100 cycles	*1*
On/Off Test	On/10sec, Off/10sec, 30,000 cycles	
ESD (Electro Static Discharge)	Contact Discharge: ± 8KV, 150pF(330Ω) 1sec, 15 points, 25 times/ point.	*2*
	Air Discharge: ± 15KV, 150pF(330Ω) 1sec 15 points, 25 times/ point.	
Altitude Test	Operation:10,000 ft Non-Operation:30,000 ft	

Note 1: The TFT-LCD module will not sustain damage after being subjected to 100 cycles of rapid temperature change. A cycle of rapid temperature change consists of varying the temperature from -20℃ to 60℃, and back again. Power is not applied during the test. After temperature cycling, the unit is placed in normal room ambient for at least 4 hours before power on.

Note 2: EN61000-4-2, ESD class B: Certain performance degradation allowed
No data lost
Self-recoverable
No hardware failures.

9.0 Mechanical Characteristics

Avoid touching COF position when doing mechanical design